Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	7644	(flexible adj substrate) and (vias or (through adj holes))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:34
L2	4949	(flexible adj substrate) and (vias or (through adj holes)) and (foil or pattern)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:35
L3	4392	(flexible adj substrate) and (vias or (plat$3 adj through adj holes)) and (foil or pattern)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:35
L4	2630	(flexible adj substrate) and (vias or (plat$3 adj through adj holes)) and (foil or pattern) and adhesive	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:35
L5	2380	(flexible adj substrate) and (vias or (plat$3 adj through adj holes)) and (foil or pattern) and adhesive and (contacts or pads)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:36
L6	2328	(flexible adj substrate) and (vias or (plat$3 adj through adj holes)) and (foil or pattern) and adhesive and (contacts or pads) and (chip or IC or device or component)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:36
L7	175	"361"/$.ccls. and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:55
L8	32	(adhesive adj substrate) and (plat$3 adj through adj hole)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:58
L9	32	(adhesive adj substrate) and (plat$3 adj through adj holes)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 13:01

L10	312	(adhesive adj substrate) and (through adj holes)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 12:58
L11	204	(adhesive adj substrate) and (through adj holes) and pattern	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 13:01
L12	333	(flexible adj substrate) and (plat$3 adj through adj holes)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 13:01
L13	1537	(flexible adj substrate) and (through adj holes) and pattern	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 13:02
L14	261	(flexible adj substrate) and (plat$3 adj through adj holes) and pattern	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT	OR	ON	2005/05/31 13:02